

H5N2519P

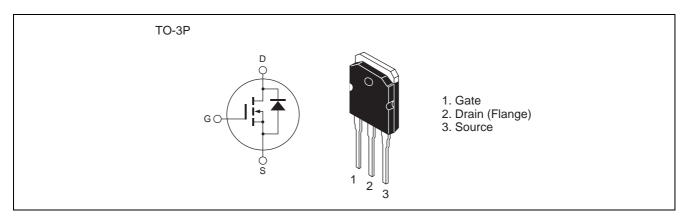
Silicon N Channel MOS FET High Speed Power Switching

REJ03G0478-0200 Rev.2.00 Nov.19.2004

Features

- Low on-resistance
- Low leakage current
- High speed switching

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to Source voltage	V _{DSS}	250	V
Gate to Source voltage	V _{GSS}	±30	V
Drain current	I _D	65	A
Drain peak current	I _{D (pulse)} Note1	195	A
Body-Drain diode reverse Drain current	I _{DR}	65	A
Avalanche current	I _{AP} Note3	22	A
Avalanche energy	E _{AR} Note3	30.2	mJ
Channel dissipation	Pch Note2	150	W
Channel to case thermal impedance	θch-c	0.833	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	−55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $Tc = 25^{\circ}C$

3. STch = 25° C, Tch $\leq 150^{\circ}$ C

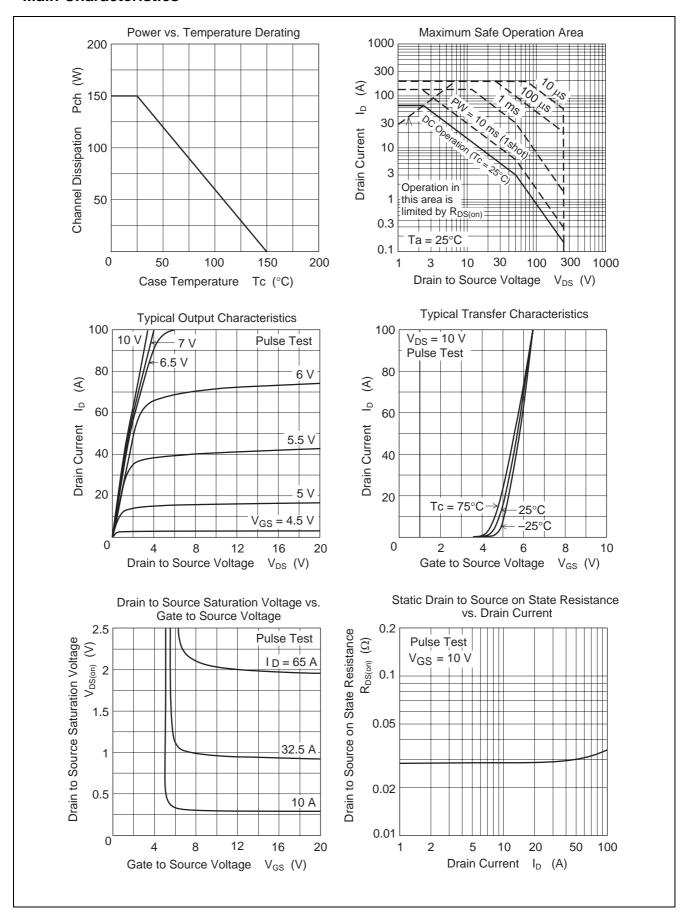
Electrical Characteristics

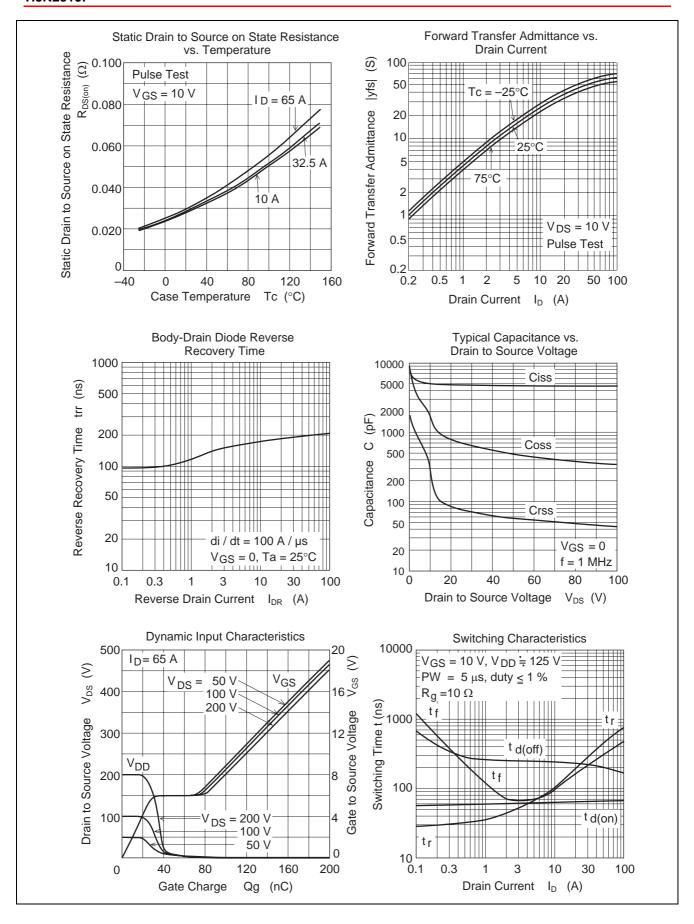
 $(Ta = 25^{\circ}C)$

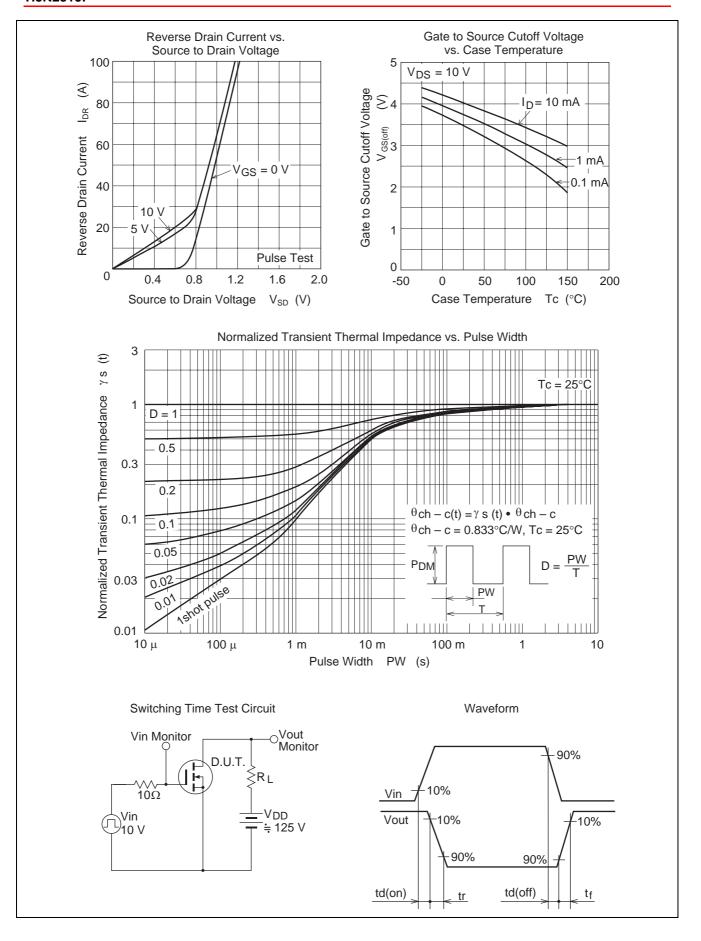
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to Source breakdown voltage	$V_{(BR)DSS}$	250	_		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Zero Gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 250 \text{ V}, V_{GS} = 0$
Gate to Source leak current	I _{GSS}	_	_	±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Gate to Source cutoff voltage	$V_{GS(off)}$	3.0	_	4.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Forward transfer admittance	yfs	28	47	_	S	$I_D = 32.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Static Drain to Source on state	R _{DS(on)}	_	0.029	0.035	Ω	$I_D = 32.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance						
Input capacitance	Ciss	_	4900		pF	V _{DS} = 25 V
Output capacitance	Coss	_	700	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	75	_	pF	f = 1 MHz
Turn-on delay time	td(on)	_	65	_	ns	I _D = 32.5 A
Rise time	tr	_	310	_	ns	$V_{GS} = 10 \text{ V}$ $R_L = 3.9 \Omega$ $Rg = 10 \Omega$
Turn-off delay time	td(off)	_	220	_	ns	
Fall time	tf	_	220	_	ns	
Total Gate charge	Qg	_	120	_	nC	V _{DD} = 200 V
Gate to Source charge	Qgs	_	28	_	nC	V _{GS} = 10 V I _D = 65 A
Gate to Drain charge	Qgd	_	52	_	nC	
Body-Drain diode forward voltage	V_{DF}	_	1.10	1.65	V	$I_F = 65 \text{ A}, V_{GS} = 0^{\text{Note4}}$
Body-Drain diode reverse recovery time	trr	_	200	_	ns	I _F = 65 A, V _{GS} = 0
Body-Drain diode reverse recovery	Qrr	_	1.6	_	μС	diF/dt = 100 A/μs
charge						

Notes: 4. Pulse test

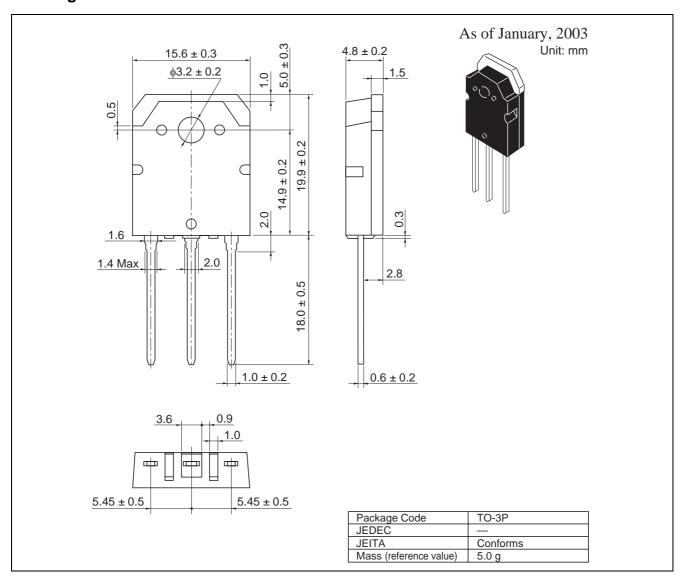
Main Characteristics







Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
H5N2519P-E	30 pcs	Plastic magazine

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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